

## C0402C331J2GACTU

Aliases (C0402C331J2GAC7867)

SMD Comm COG, Ceramic, 330 pF, 5%, 200 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0402, 0.3 mm



Click [here](#) for the 3D model.

### General Information

Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.16 mg
Shelf Life	78 Weeks
MSL	1

### Dimensions

Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
T	0.55mm +/-0.05mm
S	0.3mm MIN
B	0.3mm +/-0.1mm

### Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	10000

### Specifications

Capacitance	330 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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